

PSE Technology Corporation

SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	37.400000 MHz
PRODUCT TYPE	TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL
PART NUMBER	FH3740013Z
CUSTOMER P/N	
ISSUE DATE	August 20, 2014
VERSION	В

APPROVED	PREPARED	QA	
Brenda	Nikhi Lu	Bedryeri	
APPROVED BY CUSTOMER			

Please return one copy with approval to PSE-TW

PSE Technology Corporation

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- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

A Company of PERICOM Semiconductor Corporation

VER.B 20-AUG-14

VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Aug. 19, 2014			Initial Release	
В	Aug. 20, 2014			Updated to Frequency Stability +/-10ppm, Operating Drive Level 100uW, Maximum Drive Level 150uW, ESR 10ohms typ / 30ohms max, C0 3pF & aging +/-1ppm.	

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ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	37.400000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	± 10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-30 to +85	°C	
Frequency Stability(Frequency Deviation over the Operating Temperature Range)	F/T	± 10	ppm	Reference to the Frequency at 25°C
Operating Drive Level		100	μW	
Maximum Drive Level		150	μW	
Equivalent Series Resistance	ESR	10 / 30	Ω	Typ. / Max.
Shunt Capacitance	C0	3	pF	Max.
Aging at 25°C		± 1	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

^{**} This product doesn"t include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a)FINE LEAK TEST: JESD22-A109 (Condition 1A)

b)GROSS LEAK TEST: JESD22-A109 (Condition C)

c)MOISTURE RESISTANCE: JESD22-A113

d)SHOCK: JESD22-B104 (Condition B)

e)SOLDERABILITY: (RoHS version): J-STD-002

f)VIBRATION: JESD22-B103

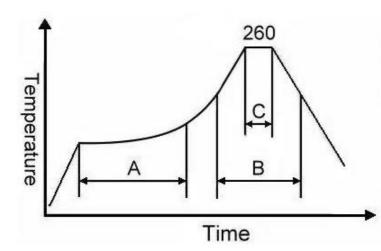
g)SOLVENT RESISTANCE: JESD22-B107

h)RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

Note:

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



	Stage	Temperature	Time	
Α	Preheat	150~200°C	60~120.5	

 A
 Preheat
 150~200°C
 60~120 Sec

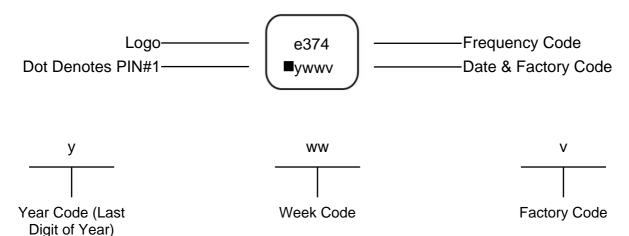
 B
 Primary Heat
 217°C
 60~150 Sec

 C
 Peak
 260°C
 10 Sec

For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

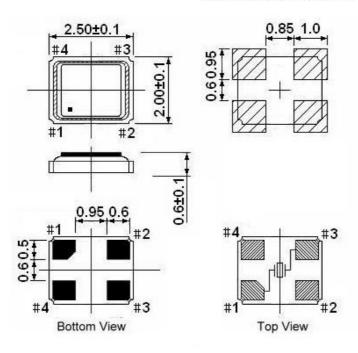
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

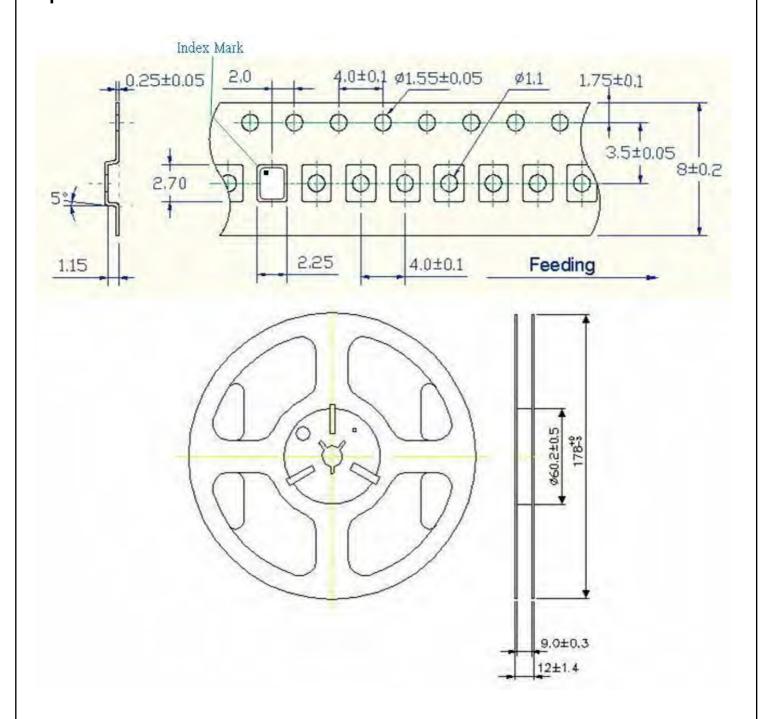
Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.



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Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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